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PRELIMINARY

NEC NEC LCD Technologies, Ltd.

TFT COLOR LCD MODULE

NL10276BC24-19D

31cm (12.1 Type)

XGA

LVDS interface (1port)

PRELIMINARY DATA SHEET 

DOD-PP-0322 (1st edition)



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INTRODUCTION

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Examples: Military systems, aircraft control equipment, aerospace equipment, nuclear reactor control systems, medical equipment/devices/systems for life support, etc.

The quality grade of this product is the "**Standard**" unless otherwise specified in this document.

CONTENTS

INTRODUCTION	2
1. OUTLINE	4
1.1 STRUCTURE AND PRINCIPLE	4
1.2 APPLICATION	4
1.3 FEATURES	4
2. GENERAL SPECIFICATIONS	5
3. BLOCK DIAGRAM	6
4. DETAILED SPECIFICATIONS	8
4.1 MECHANICAL SPECIFICATIONS	8
4.2 ABSOLUTE MAXIMUM RATINGS	8
4.3 ELECTRICAL CHARACTERISTICS	9
4.3.1 LCD panel signal processing board	9
4.3.2 Backlight	10
4.3.3 Power supply voltage ripple	10
4.3.4 Fuse	10
4.4 POWER SUPPLY VOLTAGE SEQUENCE	11
4.5 CONNECTIONS AND FUNCTIONS FOR INTERFACE PINS	12
4.6 Positions of plug and socket	13
4.7 Connection between receiver and transmitter for LVDS	14
4.8 Input data mapping	15
4.9 DISPLAY COLORS AND INPUT DATA SIGNALS	16
4.10 DISPLAY POSITIONS	17
4.11 SCANNING DIRECTIONS	17
4.12 INPUT SIGNAL TIMINGS	18
4.12.1 Outline of input signal timings	18
4.12.2 Timing characteristics	19
4.12.3 Input signal timing chart	20
4.13 OPTICS	21
4.13.1 Optical characteristics	21
4.13.2 Definition of contrast ratio	22
4.13.3 Definition of luminance uniformity	22
4.13.4 Definition of response times	22
4.13.5 Definition of viewing angles	22
5. RELIABILITY TESTS	23
6. PRECAUTIONS	24
6.1 MEANING OF CAUTION SIGNS	24
6.2 CAUTIONS	24
6.3 ATTENTIONS	24
6.3.1 Handling of the product	24
6.3.2 Environment	25
6.3.3 Characteristics	25
6.3.4 Other	25
7. OUTLINE DRAWINGS	26
7.1 FRONT VIEW	26
7.2 REAR VIEW	27
REVISION HISTORY	28

1. OUTLINE

1.1 STRUCTURE AND PRINCIPLE

Color LCD module NL10276BC24-19D is composed of the amorphous silicon thin film transistor liquid crystal display (a-Si TFT LCD) panel structure with driver LSIs for driving the TFT (Thin Film Transistor) array and a backlight.

The a-Si TFT LCD panel structure is injected liquid crystal material into a narrow gap between the TFT array glass substrate and a color-filter glass substrate.

Color (Red, Green, Blue) data signals from a host system (e.g. signal generator, etc.) are modulated into best form for active matrix system by a signal processing circuit, and sent to the driver LSIs which drive the individual TFT arrays.

The TFT array as an electro-optical switch regulates the amount of transmitted light from the backlight assembly, when it is controlled by data signals. Color images are created by regulating the amount of transmitted light through the TFT array of red, green and blue dots.

1.2 APPLICATION

- FCNOTE

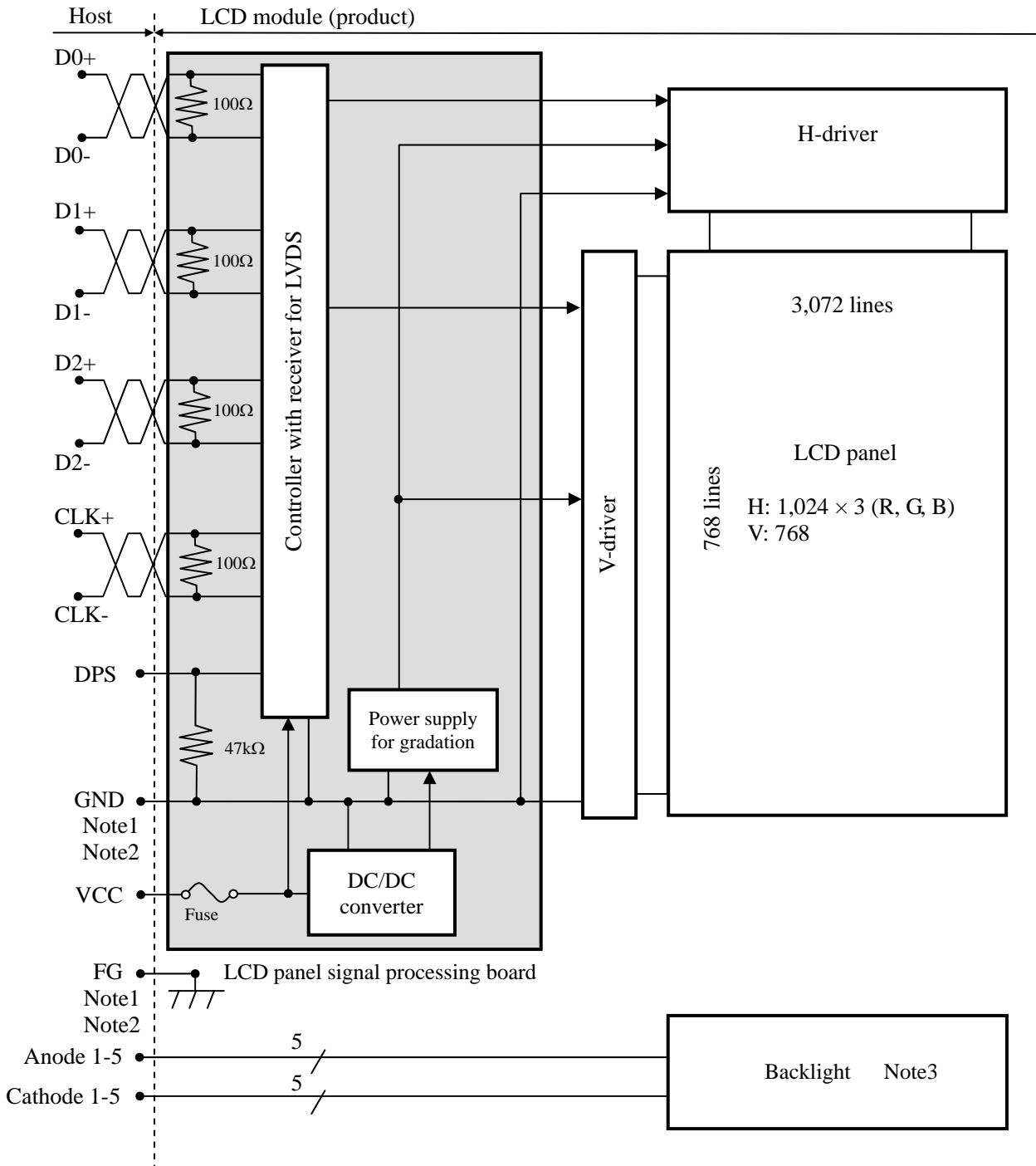
1.3 FEATURES

- High contrast
- Wide viewing angle
- LVDS interface
- Reversible-scan direction
- LED backlight type

2. GENERAL SPECIFICATIONS

Display area	245.76 (H) × 184.32 (V) mm
Diagonal size of display	31cm (12.1 inches)
Drive system	a-Si TFT active matrix
Display color	262,144 colors
Pixel	1,024 (H) × 768 (V) pixels
Pixel arrangement	RGB (Red dot, Green dot, Blue dot) vertical stripe
Dot pitch	0.08 (H) × 0.24 (V) mm
Pixel pitch	0.24 (H) × 0.24 (V) mm
Module size	260.0 (W) × 200.0 (H) × 6.9 (D) mm (typ.)
Weight	305g (typ.)
Contrast ratio	600:1 (typ.)
Viewing angle	At the contrast ratio ≥ 10:1 <ul style="list-style-type: none"> • Horizontal: Right side 70° (typ.), Left side 70° (typ.) • Vertical: Up side 60° (typ.), Down side 60° (typ.)
Designed viewing direction	At DPS= Low or Open: Normal scan <ul style="list-style-type: none"> • Viewing direction without image reversal: up side (12 o'clock) • Viewing direction with contrast peak: down side (6 o'clock) • Viewing angle with optimum grayscale ($\gamma=2.2$): normal axis (perpendicular)
Polarizer surface	Antiglare
Polarizer pencil-hardness	3H (min.) [by JIS K5400]
Color gamut	At LCD panel center 40 % (typ.) [against NTSC color space]
Response time	Ton + Toff (10% ←→ 90%) 25 ms (typ.)
Luminance	At IL=20mArm 430 cd/m ² (typ.)
Signal system	LVDS 1port (Receiver: THC63LVDF84B, THine Electronics Inc. or equivalent) 8bit/6bit digital signals for data of RGB colors, Dot clock (CLK), Data enable (DE)
Power supply voltage	LCD panel signal processing board: 3.3V
Backlight	LED backlight type
Power consumption	At IL=20mArm, Checkered flag pattern 4.3 W

3. BLOCK DIAGRAM



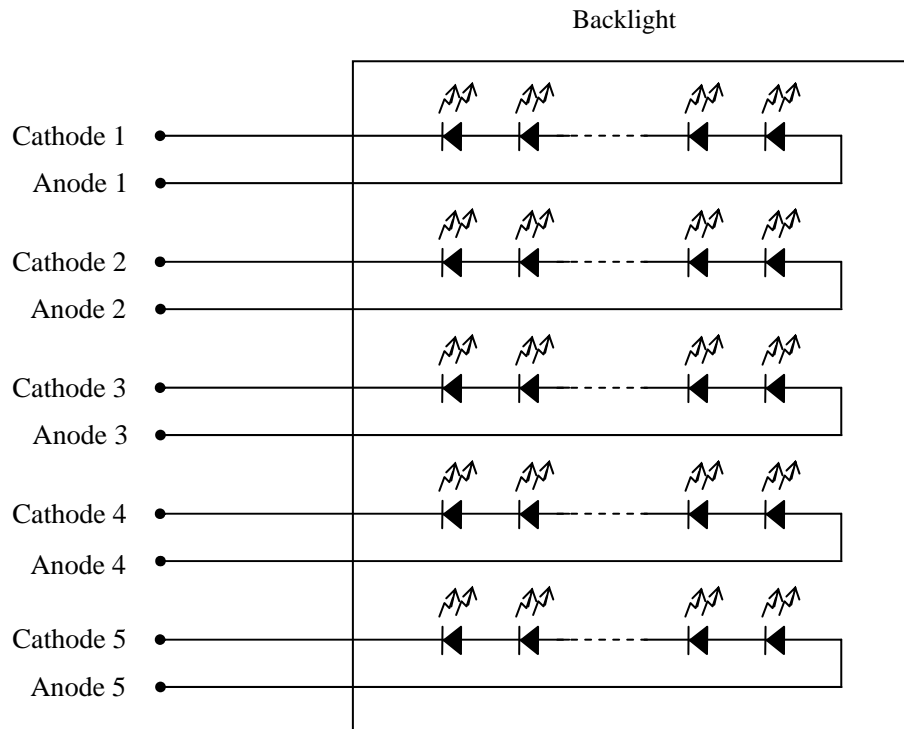
Note1: Relations between GND (Signal ground) and FG (Frame ground) in the LCD module is as follows.

GND-FG	Not connected
--------	---------------

Note2: GND and FG must be connected to customer equipment's ground, and it is recommended that GND and FG are connected together in customer equipment.

PRELIMINARY

Note3: Detail of backlight



PRELIMINARY

4. DETAILED SPECIFICATIONS

4.1 MECHANICAL SPECIFICATIONS

Parameter	Specification	Unit
Module size	260.0 ± 0.3 (W) × 200.0 ± 0.3 (H) × 6.9 ± 0.5 (D) Note1	mm
Display area	245.76 (H) × 184.32 (V) Note1	mm
Weight	305 (typ.), 320 (max.)	g

Note1: See "7. OUTLINE DRAWINGS".

4.2 ABSOLUTE MAXIMUM RATINGS

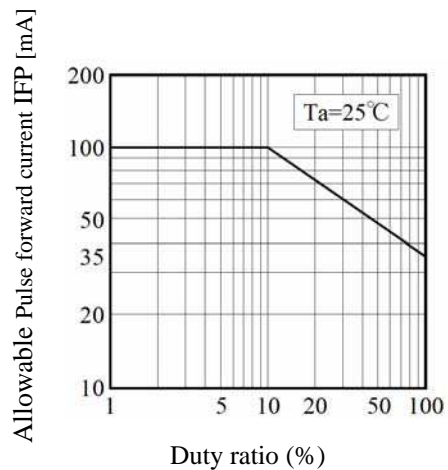
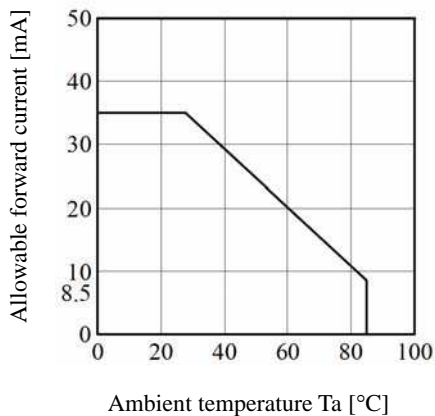
Parameter	Symbol	Rating	Unit	Remarks
Power supply voltage	VCC	-0.3 to +4.0	V	-
Input voltage for signals	VD	-0.3 to VCC+0.3	V	
	Function signal Note2			VF
Backlight	Power dissipation	PD	1.1	per one circuit
	Forward current	IL	Note3	
	Pulse forward current	IFP	Note4	
Storage temperature	Tst	-20 to +60	°C	-
Operating temperature	Top	-20 to +60	°C	Note5
Relative humidity Note6	RH	≤ 95	%	Ta ≤ 40°C
		≤ 85	%	40°C < Ta ≤ 50°C
		≤ 55	%	50°C < Ta ≤ 60°C
Absolute humidity Note6	AH	≤ 71 Note7	g/m ³	Ta > 60°C

Note1: D0+/-, D1+/-, D2+/-, CLK+/-

Note2: DPS

Note3: Forward current

Note4: Pulse forward current



Note5: Measured at center of LCD panel surface (including self-heat)

Note6: No condensation

Note7: Water amount at Ta= 60°C and RH= 55%

PRELIMINARY

4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD panel signal processing board

(Ta = 25°C)

Parameter	Symbol	min.	typ.	max.	Unit	Remarks	
Power supply voltage	VCC	3.0	3.3	3.6	V	-	
Power supply current	ICC	-	420 Note1	680 Note2	mA	at VCC = 3.3V	
Permissible ripple voltage	VRP	-	-	100	mVp-p	for VCC	
Differential input threshold voltage for LVDS receiver	High	VTH	-	-	+100	mV	at VCM=1.2V Note3
	Low	VTL	-100	-	-	mV	
Terminating resistance	RT	-	100	-	Ω	-	
Input voltage for DPS signal	High	VFH	0.7VCC	-	VCC	V	CMOS level
	Low	VFL	0	-	0.3VCC	V	

Note1: Checkered flag pattern [by EIAJ ED-2522]

Note2: Pattern for maximum current

Note3: Common mode voltage for LVDS receiver

PRELIMINARY

4.3.2 Backlight

(Ta= 25°C)

Parameter	Symbol	min.	typ.	max.	Unit	Remarks
Forward Current	IL	-	20	35	mA	-
Forward Voltage	VL	-	28.8	31.5	V	at IL= 20 mA

Note1: Please drive with constant current.

Note2: The Luminance uniformity may be changed depending on the current variation between 5 circuits. It is recommended that the current value difference between each circuit is less than 5%.

4.3.3 Power supply voltage ripple

This product works, even if the ripple voltage levels are beyond the permissible values as following the table, but there might be noise on the display image.

Power supply voltage		Ripple voltage (Measure at input terminal of power supply)	Note1	Unit
VCC	3.3 V	≤ 100		mVp-p

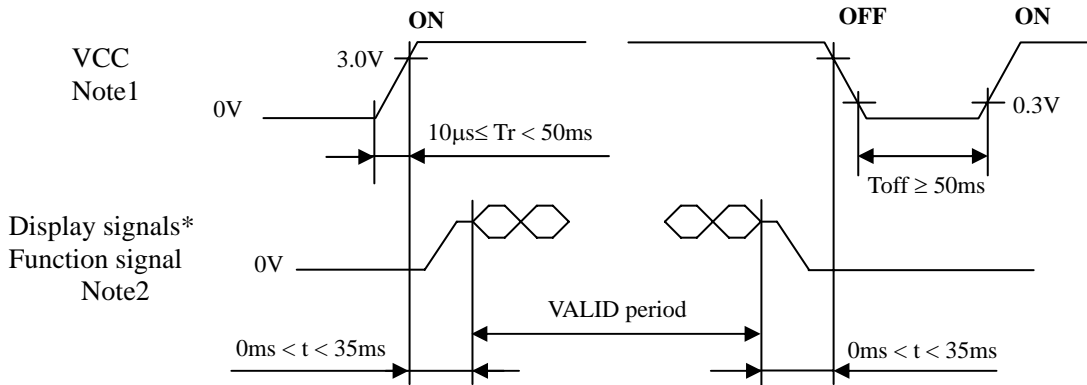
Note1: The permissible ripple voltage includes spike noise.

4.3.4 Fuse

Parameter	Fuse		Rating	Fusing current	Remarks
	Type	Supplier			
VCC	FCC16202AB	KAMAYA ELECTRIC Co., Ltd.	2.0A	4.0A	Note1
			32V		

Note1: The power supply capacity should be more than the fusing current. If it is less than the fusing current, the fuse may not blow in a short time, and then nasty smell, smoke and so on may occur.

4.4 POWER SUPPLY VOLTAGE SEQUENCE



* These signals should be measured at the terminal of 100Ω resistance.

Note1: In terms of voltage variation (voltage drop) while VCC rising edge is below 3.0V, a protection circuit may work, and then this product may not work.

Note2: Display signals (D0+/-, D1+/-, D2+/- and CLK+/-) and function signal (DPS) must be Low or High-impedance, exclude the VALID period (See above sequence diagram), in order to avoid that internal circuits is damaged.

If some of display and function signals of this product are cut while this product is working, even if the signal input to it once again, it might not work normally. If customer stops the display and function signals, they should be cut VCC.

Note3: The backlight should be turned on within the valid period of display and function signals, in order to avoid unstable data display.

PRELIMINARY

4.5 CONNECTIONS AND FUNCTIONS FOR INTERFACE PINS

CN1 socket (LCD module side): FI-XB30SL-HF10 (Japan Aviation Electronics Industry Limited (JAE))

Adaptable plug: FI-X30* (Japan Aviation Electronics Industry Limited (JAE))

Pin No.	Symbol	Signal	Remarks
1	VCC	Power supply	Note1
2	VCC		
3	GND	Ground	Note1
4	GND		
5	D0-	Pixel data	Note2
6	D0+		
7	GND	Ground	Note1
8	D1-	Pixel data	Note2
9	D1+		
10	GND	Ground	Note1
11	D2-	Pixel data	Note2
12	D2+		
13	GND	Ground	Note1
14	CLK-	Pixel clock	Note2
15	CLK+		
16	GND	Ground	Note1
17	GND	Ground	Note1
18	DPS	Selection of scan direction	High: Reverse scan Low or Open: Normal scan Note3
19	GND	Ground	Note1
20	GND	Ground	Note1
21	K1	Cathode 1	-
22	A1	Anode 1	-
23	K2	Cathode 2	-
24	A2	Anode 2	-
25	K3	Cathode 3	-
26	A3	Anode 3	-
27	K4	Cathode 4	-
28	A4	Anode 4	-
29	K5	Cathode 5	-
30	A5	Anode 5	-

Note1: All GND and VCC terminals should be used without any non-connected lines

Note2: Twist pair wires with 100Ω (Characteristic impedance) should be used between LCD panel signal processing board and LVDS transmitter.

Note3: See "4.11 SCANNING DIRECTIONS".

Note4: See "4.7 Connection between receiver and transmitter for LVDS".

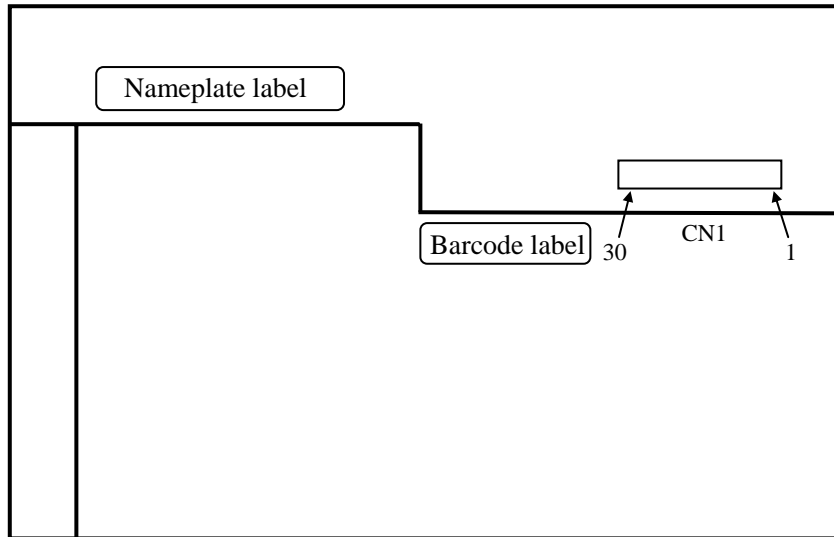
PRELIMINARY

4.6 Positions of plug and socket

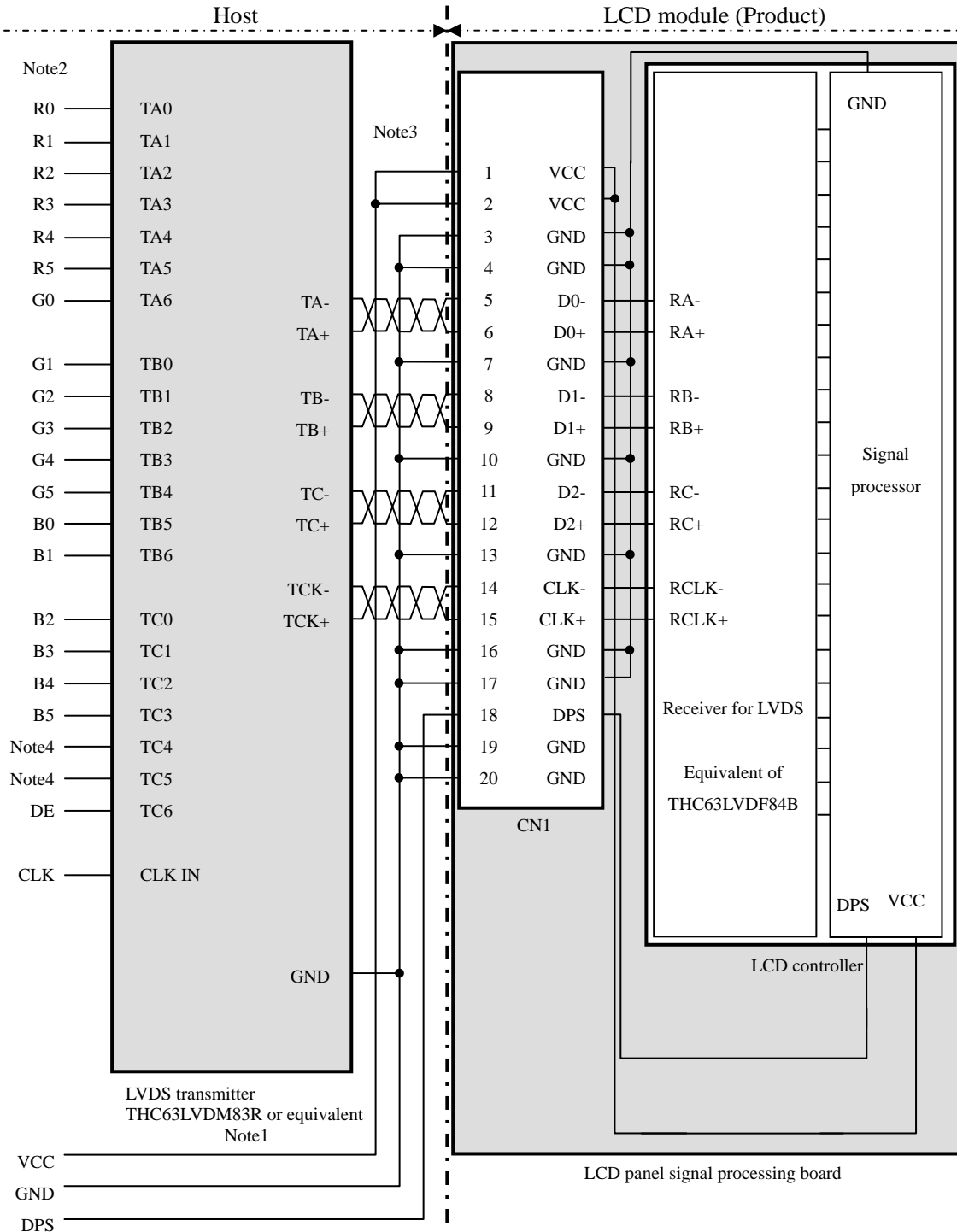
Side of the product



Rear side



4.7 Connection between receiver and transmitter for LVDS



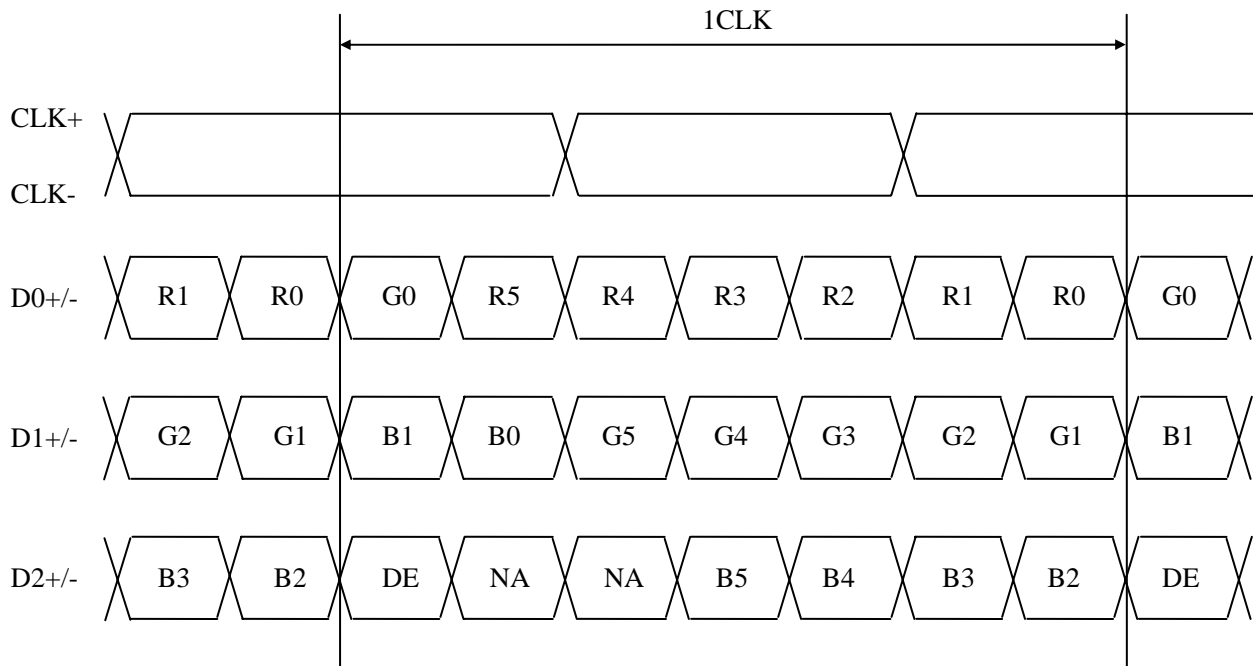
Note1: Recommended transmitter THC63LVDM83R (THine Electronics Inc.) or equivalent.

Note2: LSB (Least Significant Bit) – R0, G0, B0 MSB (Most Significant Bit) – R5, G5, B5

Note3: Twist pair wires with 100Ω (Characteristic impedance) should be used between LCD panel signal processing board and LVDS transmitter.

Note4: Input signals to TC4 and TC5 are not used inside the product, but do not keep TC4 and TC5 open to avoid noise problem.

4.8 Input data mapping



NA: Not available

PRELIMINARY

4.9 DISPLAY COLORS AND INPUT DATA SIGNALS

This product can display equivalent of 262,144 colors in 64 gray scales. Also the relation between display colors and input data signals is as the following table.

Display colors		Data signal (0: Low level, 1: High level)																	
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Red gray scale	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	↑				⋮														
	↓				⋮														
	bright	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
Green gray scale	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	↑				⋮														
	↓				⋮														
	bright	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0	
Blue gray scale	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	↑				⋮														
	↓				⋮														
	bright	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0	
Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	

4.10 DISPLAY POSITIONS

The following table is the coordinates per pixel (See "4.11 SCANNING DIRECTIONS".).

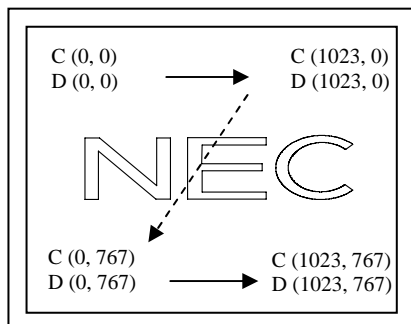
$C(0, 0)$

R	G	B
---	---	---

$C(0, 0)$	$C(1, 0)$...	$C(X, 0)$...	$C(1022, 0)$	$C(1023, 0)$
$C(0, 1)$	$C(1, 1)$...	$C(X, 1)$...	$C(1022, 1)$	$C(1023, 1)$
.
.
.
$C(0, Y)$	$C(1, Y)$...	$C(X, Y)$...	$C(1022, Y)$	$C(1023, Y)$
.
.
.
$C(0, 766)$	$C(1, 766)$...	$C(X, 766)$...	$C(1022, 766)$	$C(1023, 766)$
$C(0, 767)$	$C(1, 767)$...	$C(X, 767)$...	$C(1022, 767)$	$C(1023, 767)$

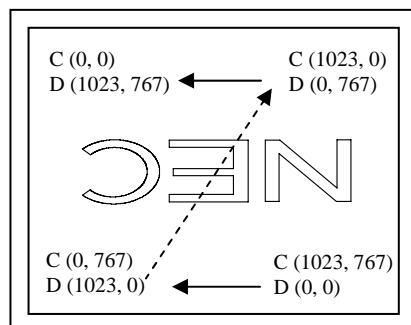
4.11 SCANNING DIRECTIONS

The following figures are seen from a front view. Also the arrow shows the direction of scan.



Note1

Figure 1. Normal scan (DPS: Low or Open)



Note1

Figure 2. Reverse scan (DPS: High)

Note1: Meaning of C (X, Y) and D (X, Y)

C (X, Y): The coordinates of the display position (See "4.10 DISPLAY POSITIONS".)

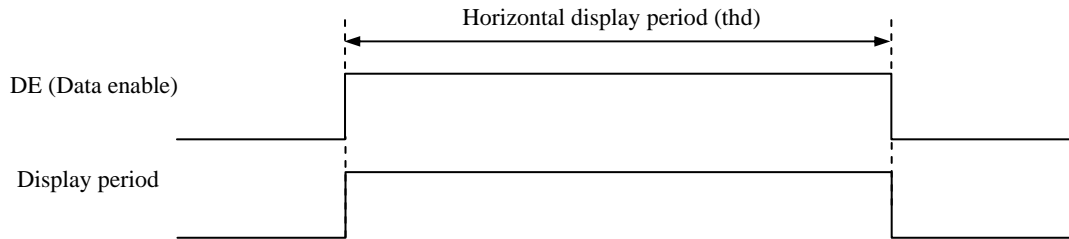
D (X, Y): The data number of input signal for LCD panel signal processing board

4.12 INPUT SIGNAL TIMINGS

4.12.1 Outline of input signal timings

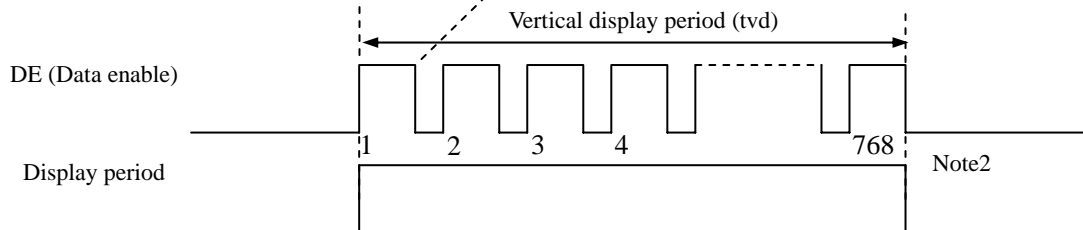
- Horizontal signal

Note1



- Vertical signal

Note1



Note1: This diagram indicates virtual signal for set up to timing.

Note2: See "**4.12.3 Input signal timing chart**" for numeration of pulse.

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4.12.2 Timing characteristics

(Note1, Note2)

Parameter		Symbol	min.	typ.	max.	Unit	Remarks	
CLK	Frequency	1/tc	60.0	65.0	68.0	MHz	15.385 ns (typ.)	
	Duty	-	-			-	-	
	Rise time, Fall time	-				ns		
DATA	CLK-DATA	Setup time	-			ns	-	
		Hold time				ns		
	Rise time, Fall time					ns		
DE	Horizontal	Cycle	th	19.67	20.676	22.4	μs	48.363 kHz (typ.)
		Display period	thd	-	1,344	-	CLK	-
	Vertical (One frame)	Cycle	tv	13.3	16.666	18.5	ms	60.0 Hz (typ.)
		Display period	tvd	780	806	-	H	-
	CLK-DE	Setup time	-	-			ns	-
		Hold time	-				ns	
		Rise time, Fall time	-				ns	

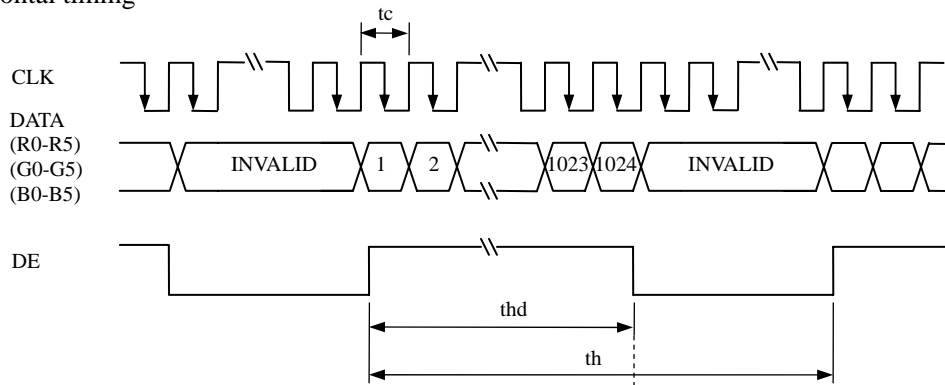
Note1: Definition of parameters is as follows.

$$tc = 1CLK, th = 1H$$

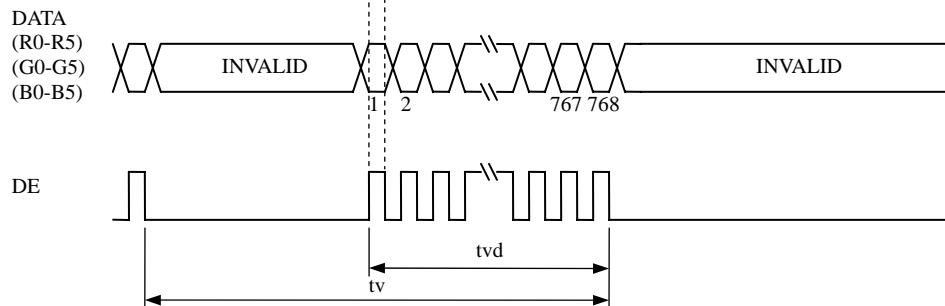
Note2: See the data sheet of LVDS transmitter.

4.12.3 Input signal timing chart

Horizontal timing



Vertical timing



4.13 OPTICS

4.13.1 Optical characteristics

(Note1, Note2)

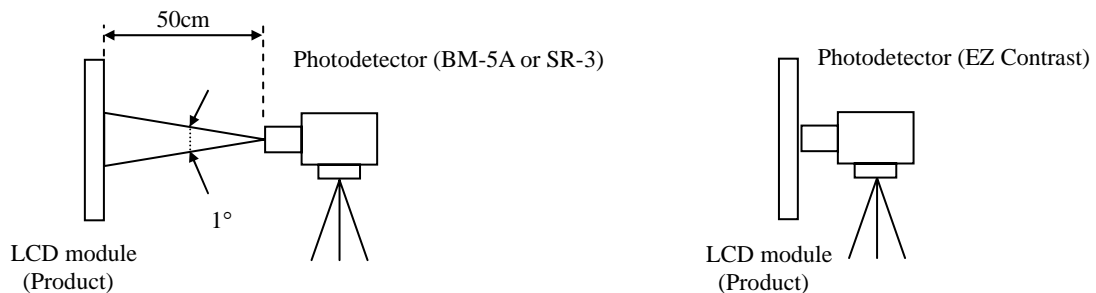
Parameter	Condition	Symbol	min.	typ.	max.	Unit	Measuring instrument	Remarks	
Luminance	White at center $\theta R=0^\circ, \theta L=0^\circ, \theta U=0^\circ, \theta D=0^\circ$	L	TBD	430	-	cd/m ²	BM-5A	-	
Contrast ratio	White/Black at center $\theta R=0^\circ, \theta L=0^\circ, \theta U=0^\circ, \theta D=0^\circ$	CR	300	600	-	-	BM-5A	Note3	
Luminance uniformity	White $\theta R=0^\circ, \theta L=0^\circ, \theta U=0^\circ, \theta D=0^\circ$	LU	-	1.25	1.40	-	BM-5A	Note4	
Chromaticity	White	x coordinate	W _x	TBD	TBD	TBD	-	SR-3	Note5
		y coordinate	W _y	TBD	TBD	TBD	-		
	Red	x coordinate	R _x	-	TBD	-	-		
		y coordinate	R _y	-	TBD	-	-		
	Green	x coordinate	G _x	-	TBD	-	-		
		y coordinate	G _y	-	TBD	-	-		
Blue	x coordinate	B _x	-	TBD	-	-			
	y coordinate	B _y	-	TBD	-	-			
Color gamut	$\theta R=0^\circ, \theta L=0^\circ, \theta U=0^\circ, \theta D=0^\circ$ at center, against NTSC color space	C	35	40	-	%			
Response time	White to Black	T _{on}	-	6	15	ms	BM-5A	Note6	
	Black to White	T _{off}	-	19	47	ms		Note7	
Viewing angle	Right	$\theta U=0^\circ, \theta D=0^\circ, CR \geq 10$	θR	TBD	(70)	-	EZ Contrast	Note8	
	Left	$\theta U=0^\circ, \theta D=0^\circ, CR \geq 10$	θL	TBD	(70)	-			
	Up	$\theta R=0^\circ, \theta L=0^\circ, CR \geq 10$	θU	TBD	(60)	-			
	Down	$\theta R=0^\circ, \theta L=0^\circ, CR \geq 10$	θD	TBD	(60)	-			

Note1: These are initial characteristics.

Note2: Measurement conditions are as follows.

T_a = 25°C, VCC = 3.3V, I_L = 20mA, Display mode: XGA, Horizontal cycle = 1/48.363kHz, Vertical cycle = 1/60.0Hz, DPS= Low or Open: Normal scan

Optical characteristics are measured at luminance saturation after 20minutes from working the product, in the dark room. Also measurement methods are as follows.



Note3: See "4.13.2 Definition of contrast ratio".

Note4: See "4.13.3 Definition of luminance uniformity".

Note5: These coordinates are found on CIE 1931 chromaticity diagram.

Note6: Product surface temperature: TopF = TBD°C

Note7: See "4.13.4 Definition of response times".

Note8: See "4.13.5 Definition of viewing angles".

4.13.2 Definition of contrast ratio

The contrast ratio is calculated by using the following formula.

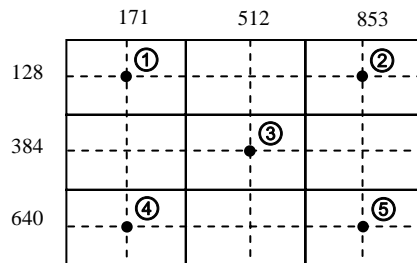
$$\text{Contrast ratio (CR)} = \frac{\text{Luminance of white screen}}{\text{Luminance of black screen}}$$

4.13.3 Definition of luminance uniformity

The luminance uniformity is calculated by using following formula.

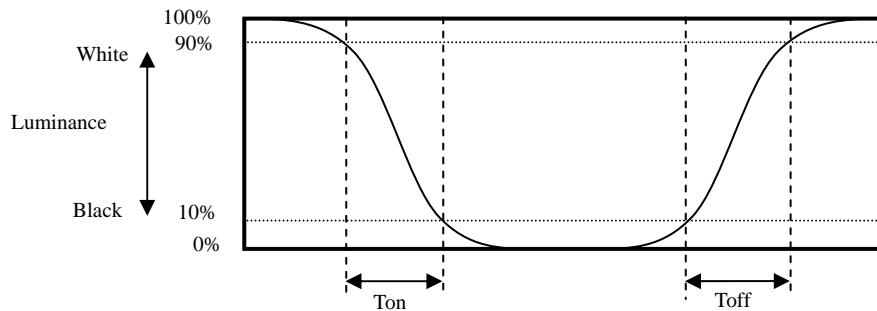
$$\text{Luminance uniformity (LU)} = \frac{\text{Maximum luminance from ① to ⑤}}{\text{Minimum luminance from ① to ⑤}}$$

The luminance is measured at near the 5 points shown below.

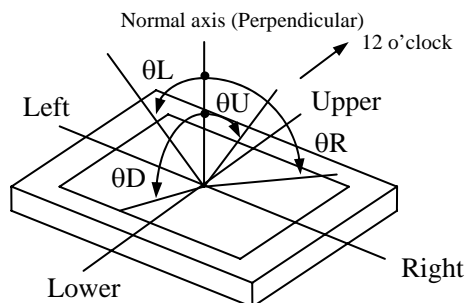


4.13.4 Definition of response times

Response time is measured, the luminance changes from "white" to "black", or "black" to "white" on the same screen point, by photo-detector. Ton is the time it takes the luminance change from 90% down to 10%. Also Toff is the time it takes the luminance change from 10% up to 90% (See the following diagram.).



4.13.5 Definition of viewing angles



PRELIMINARY

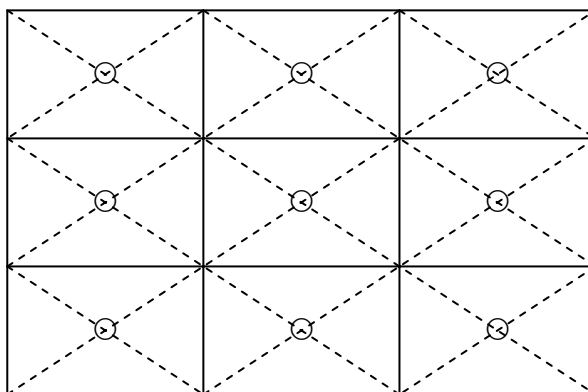
5. RELIABILITY TESTS

(Note1)

Test item	Condition	Judgment
High temperature and humidity (Operation)	① $60 \pm 2^{\circ}\text{C}$, RH = 60%, 240hours ② Display data is black.	No display malfunctions
Heat cycle (Operation)	① $-20 \pm 3^{\circ}\text{C}$...1hour $60 \pm 3^{\circ}\text{C}$...1hour ② 50cycles, 4hours/cycle ③ Display data is black.	
Thermal shock (Non operation)	① $-20 \pm 3^{\circ}\text{C}$...30minutes $60 \pm 3^{\circ}\text{C}$...30minutes ② 100cycles, 1hour/cycle ③ Temperature transition time is within 5 minutes.	
ESD (Operation)	① 150pF, 150Ω, $\pm 10\text{kV}$ ② 9 places on a panel surface Note2 ③ 10 times each points at 1 sec interval	
Dust (Operation)	① Sample dust: No. 15 (by JIS-Z8901) ② 15 seconds stir ③ 8 times repeat at 1 hour interval	
Vibration (Non operation)	① 5 to 100Hz, 19.6m/s^2 ② 1 minute/cycle ③ X, Y, Z direction ④ 120 times each directions	No display malfunctions No physical damages
Mechanical shock (Non operation)	① 539m/s^2 , 11ms ② $\pm X$, $\pm Y$, $\pm Z$ direction ③ 5 times each directions	

Note1: Display and appearance are checked under environmental conditions equivalent to the inspection conditions of defect criteria.

Note2: See the following figure for discharge points.



6. PRECAUTIONS

6.1 MEANING OF CAUTION SIGNS

The following caution signs have very important meaning. **Be sure to read "6.2 CAUTIONS" and "6.3 ATTENTIONS", after understanding these contents!**



This sign has the meaning that customer will be injured by himself, if customer has wrong operations.



This sign has the meaning that customer will be injured by himself or the product will sustain a damage, if customer has wrong operations.

6.2 CAUTIONS



- * **Do not touch the working backlight. There is a danger of burn injury.**
- * **Do not shock and press the LCD panel and the backlight! There is a danger of breaking, because they are made of glass. (Shock: To be not greater 539m/s² and to be not greater 11ms, Pressure: To be not greater 19.6 N (φ16mm jig))**

6.3 ATTENTIONS



6.3.1 Handling of the product

- ① Take hold of both ends without touching the circuit board when the product (LCD module) is picked up from inner packing box to avoid broken down or misadjustment, because of stress to mounting parts on the circuit board.
- ② Do not hook nor pull cables such as lamp cable, and so on, in order to avoid any damage.
- ③ When the product is put on the table temporarily, display surface must be placed downward.
- ④ When handling the product, take the measures of electrostatic discharge with such as earth band, ionic shower and so on, because the product may be damaged by electrostatic.
- ⑤ The product must be installed without undue stress such as bends or twist. And do not add undue stress to any portion (such as bezel flat area). Bends or twist described above and undue stress to any portion may cause display mura.
- ⑥ Do not press or rub on the sensitive product surface. When cleaning the product surface, use of the cloth with ethanolic liquid such as screen cleaner for LCD is recommended.
- ⑦ Do not push nor pull the interface connectors while the product is working.
- ⑧ When handling the product, use of an original protection sheet on the product surface (polarizer) is recommended for protection of product surface. Adhesive type protection sheet may change color or characteristics of the polarizer.
- ⑨ Usually liquid crystals don't leak through the breakage of glasses because of the surface tension of thin layer and the construction of LCD panel. But, if you contact with liquid crystal for the worst, please wash it out with soap.

6.3.2 Environment

- ① Do not operate or store in high temperature, high humidity, dewdrop atmosphere or corrosive gases. Keep the product in packing box with antistatic pouch in room temperature to avoid dusts and sunlight, when storing the product.
- ② In order to prevent dew condensation occurring by temperature difference, the product packing box should be opened after enough time being left under the environment of an unpacking room. Evaluate the leaving time sufficiently because a situation of dew condensation occurring is changed by the environmental temperature and humidity. (Recommended leaving time: 6 hours or more with packing state)
- ③ Do not operate in high magnetic field. Circuit boards may be broken down by it.
- ④ This product is not designed as radiation hardened.

6.3.3 Characteristics

The following items are neither defects nor failures.

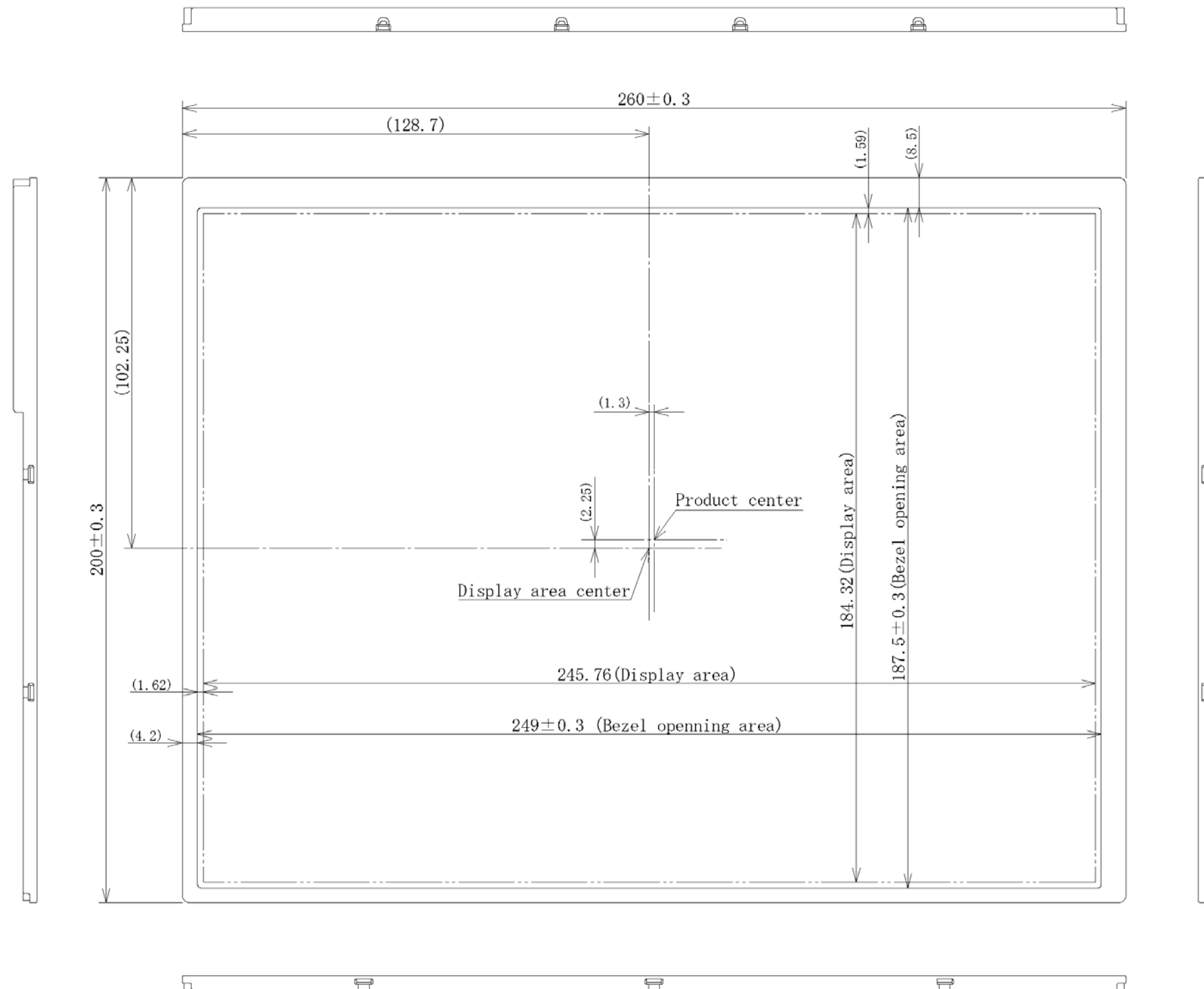
- ① Response time, luminance and color may be changed by ambient temperature.
- ② Display mura, flicker, vertical seam or small spot may be observed depending on display patterns.
- ③ Do not display the fixed pattern for a long time because it may cause image sticking. Use a screen saver, if the fixed pattern is displayed on the screen.
- ④ The display color may be changed depending on viewing angle because of the use of condenser sheet in the backlight.
- ⑤ Optical characteristics may be changed depending on input signal timings.

6.3.4 Other

- ① All GND and VCC terminals should be used without any non-connected lines.
- ② Do not disassemble a product or adjust variable resistors.
- ⑤ Pack the product with original shipping package, in order to avoid any damages during transportation, when returning the product to NEC for repair and so on.

PRELIMINARY

7. OUTLINE DRAWINGS 7.1 FRONT VIEW

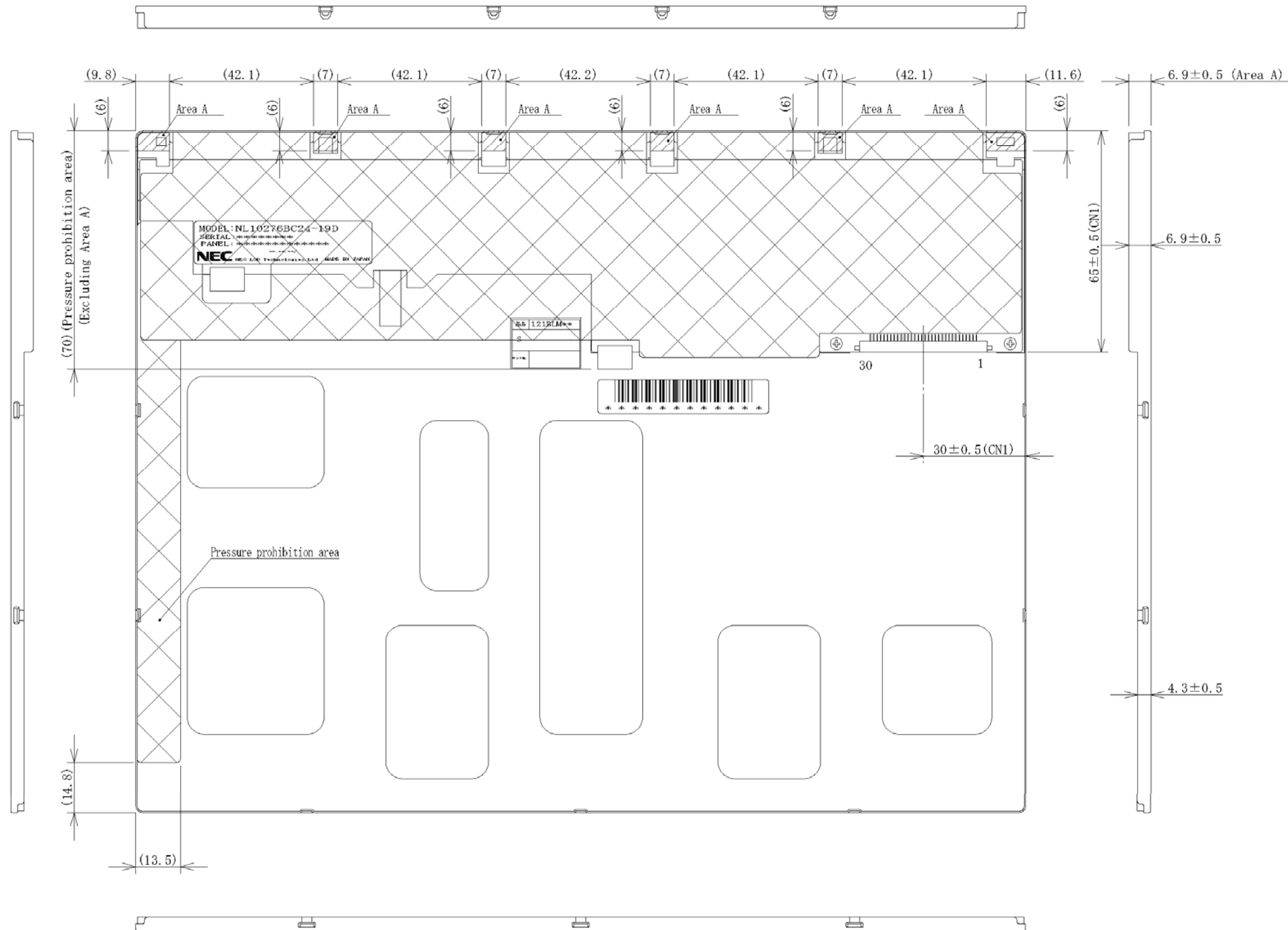


Note1: The values in parentheses are for reference.

Unit: mm

PRELIMINARY

7.2 REAR VIEW




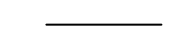


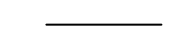


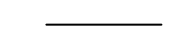

Note1: The values in parentheses are for reference.

Unit: mm

PRELIMINARY

REVISION HISTORY

The inside of latest specifications is revised to the clerical error and the major improvement of previous edition. Only a changed part such as functions, characteristic value and so on that may affect a design of customers, are described especially below.

Edition	Document number	Prepared date	Revision contents and signature									
1st edition	DOD-PP-0322	Jul. 20, 2007	<p>Revision contents</p> <p>New issue.</p> <p>Signature of writer</p> <table data-bbox="558 672 1420 806"><tr><td data-bbox="558 672 829 716"><i>Approved by</i></td><td data-bbox="877 672 1101 716"><i>Checked by</i></td><td data-bbox="1149 672 1420 716"><i>Prepared by</i></td></tr><tr><td data-bbox="558 716 829 761"></td><td data-bbox="877 716 1101 761"></td><td data-bbox="1149 716 1420 761"></td></tr><tr><td data-bbox="558 761 829 806">T. OGAWA</td><td data-bbox="877 761 1101 806"></td><td data-bbox="1149 761 1420 806">M. TANAKA</td></tr></table>	<i>Approved by</i>	<i>Checked by</i>	<i>Prepared by</i>				T. OGAWA		M. TANAKA
<i>Approved by</i>	<i>Checked by</i>	<i>Prepared by</i>										
												
T. OGAWA		M. TANAKA										